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Renesas Electronics Corporation

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R8C/Tiny Series

General-purpose Program for Example for Initial Setting Assembler

1. Abstract

This program is an example of initial settings accomplished by using the directive commands of the assembler.

2. Introduction

The program shown here consists of the following:

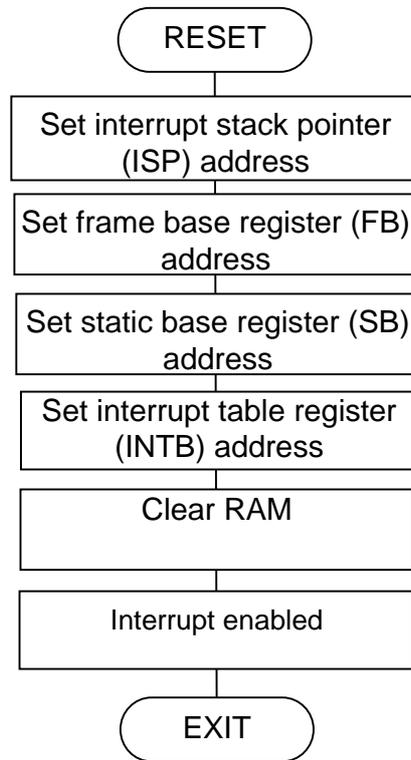
- (1) Map file information output
- (2) Global symbol name specification
- (3) Numeric symbol definition
- (4) RAM area allocation
- (5) Bit symbol definition
- (6) Initial setup program
 - Interrupt stack pointer setting
 - FB register setting
 - SB register setting
 - INTB register setting
 - RAM clear
- (7) Peripheral I/O interrupt vector table
- (8) Nonmaskable interrupt fixed vector table

The following shows the range of the FB and SB relative addresses in this program.

FB	380H to 47FH -128 ↑ -400H ↓ + 127
SB	480H to 57FH 480H ↓ + 255

This program can also be used when operating other microcomputers within the R8C /10 group, provided they have the same vector table as the R8C microcomputers. However, some functions may have been modified. Refer to the User's Manual for details. Use functions covered in this Application Note only after careful evaluation.

3. Flowchart



4. The example of a reference program

```

;*****
;
;
; R8C Program Collection No. 30
; CPU : R8C/Tiny
;
;*****
;=====
; Title: Initial settings using assembler's directive commands
; Outline:
; (1) Assemble control
; (2) Address control
; (3) Link control
; (4) List control
; (5) Branch instruction optimization control
; Notes:
;=====
;-----;
; Map file information output ;
;-----;
; .VER 'Ver1.02' ; 'Ver1.02' is output when generating map file
; ;
;-----;
; Global symbol name specification ;
;-----;
; ; [Global symbol specification]
; .GLB RUTINE ; Externlly referenced symbol
; .GLB MAIN ; Public symbol
; ;
; ; [Global bit symbol specification]
; .BTGLB P3_0 ; Externlly referenced symbol
; .BTGLB P0_7 ; Public symbol
; ;
;-----;
; Numeric symbol definition ;
;-----;
VramTOP .EQU 000400H ; Declares start address of RAM
VramEND .EQU 0006FFH ; Declares last address of RAM
Vlstack .EQU 000600H ; Interrupt stack pointer
VproTOP .EQU 00D000H ; Declares start address of program
VECTOR_ADR .EQU 00FE00h ; Declares start address of variable vector table
FIX_VECTOR.EQU 00FFDCh ; Declares fixed interrupt vector address
; ;
CNT125ms .EQU 125 ; Sets 125 in CNT125ms
; ;
AUTOchar .EQU -8 ; Sets -8 in AUTOchar
; ;
; .FORM 45,160 ; [List output control instruction]
; ; Specifies 45 lines, 160 columns per page of list file

```

```

        .LIST      ON                ; [List output control]
;                                           ; Outputs assembler list
;
        .PAGE     'RAM'             ; [List page break and title specification]
        .SECTION  MEMORY,DATA      ; [Section name specification]
;                                           ; Declares DATA attribute section of section name "MEMORY"
        .ORG      VramTOP           ; [Absolute address setting]
;                                           ; Sets location to 400H
;-----;
;   RAM area allocation
;-----;
;                                           ; [RAM area 1-byte allocation]
CHAR:   .BLKB    10                ; Allocates 10-byte area
;                                           ;
;                                           ; [RAM area 2-byte allocation]
SHORT:  .BLKW   10                ; Allocates 20-byte area
;                                           ;
;                                           ; [RAM area 3-byte allocation]
ADDR:   .BLKA   10                ; Allocates 30-byte area
;                                           ;
;                                           ; [RAM area 4-byte allocation]
LONG:   .BLKL   10                ; Allocates 40-byte area
;                                           ;
;                                           ; [Single-precision, floating-point RAM area allocation]
SFLOAT: .BLKF   10                ; Allocates 40-byte area
;                                           ;
;                                           ; [Double-precision, floating-point RAM area allocation]
DFLOAT: .BLKD   10                ; Allocates 80-byte area
;                                           ;
CHECK:  .BLKW   10                ;
;                                           ;
;-----;
;   Bit symbol definition
;-----;
BIT4    .BTEQU   4,CHAR            ; Sets bit 4 of displacement CHAR to BIT4
MSB     .BTEQU   15,SHORT          ; Sets bit 15 of displacement SHORT to MSB
P0_7    .BTEQU   7,3E0H           ; Sets bit 7 at address 3E0 to P0_7
;                                           ;
        .SECTION  PROG,CODE        ; Declares CODE attribute section of section name "PROG"
        .ORG      VproTOP          ; Sets location to F000H
        .OPTJ     OFF              ; [Branch instruction optimize specification]
;                                           ; Does not optimize branch instruction after this line
        .FB      VramTOP           ; [Assumption of FB register value]
;                                           ; Assumes 400H for FB register value
        .SB      VramTOP+80H       ; [Assumption of SB register value]
;                                           ; Assumes 480H for SB register value
        .FBSYM   SHORT            ;
        .SBSYM   CHECK            ;
;-----;
;   Program start
;-----;

```

```

RESET:
;
LDC    #Vlstack,ISP          ; Sets interrupt stack pointer
;
LDC    #VramTOP,FB          ; Sets frame base register
LDC    #VramTOP+80H,SB      ; Sets static base register
LDINTB #VECTOR_ADR         ; Sets interrupt table register
;
MOV.W  #0,R0                ; Sets store data (0)
MOV.W  #((VramEND+1)-VramTOP)/2,R3 ; Sets number of transfers performed
MOV.W  #VramTOP,A1         ; Sets address where to start storing
SSTR.W                                ; Executes clearing of RAM
;
FSET   I                    ; Enables interrupt
;
=====;
;   Main program
;
=====;
MAIN:
MOV.W  #1234H,SHORT
;
;
MOV.W  #5678H,CHECK
;
;
JSR    ROUTINE
BSET   P0_7
;
;   (Here is your program.)

ROUTINE:
;
;   (Here is your program.)

RTS

NOTUSE:
;
;   (Here is your program.)

RTS

.PAGE    'VECTOR'
.SECTION UINTER,ROMDATA ; Declares FOMDATA attribute section of section name "UINTER"
.org     VECTOR_ADR
;
-----;
;   Peripheral I/O interrupt vector table
;
-----;
.word    NOTUSE          ; BRK instruction      (vector 0)
.org     (VECTOR_ADR+52)
.word    NOTUSE          ; Key input interrupt  (vector 13)

```

```

.word    NOTUSE                ; A-D                (vector 14)
.org     (VECTOR_ADR+68)
.word    NOTUSE                ; UART0 transmit   (vector 17)
.word    NOTUSE                ; UART0 receive    (vector 18)
.word    NOTUSE                ; UART1 transmit   (vector 19)
.word    NOTUSE                ; UART1 receive    (vector 20)
.word    NOTUSE                ; INT2             (vector 21)
.word    NOTUSE                ; Timer X          (vector 22)
.word    NOTUSE                ; Timer Y          (vector 23)
.word    NOTUSE                ; Timer Z          (vector 24)
.word    NOTUSE                ; INT1            (vector 25)
.word    NOTUSE                ; INT3            (vector 26)
.word    NOTUSE                ; Timer C         (vector 27)
.org     (VECTOR_ADR+116)
.word    NOTUSE                ; INT0            (vector 29)
.org     (VECTOR_ADR+128)
.word    NOTUSE                ; vector 32 (for user or MR30)
.word    NOTUSE                ; vector 33 (for user or MR30)
.word    NOTUSE                ; vector 34 (for user or MR30)
.word    NOTUSE                ; vector 35 (for user or MR30)
.word    NOTUSE                ; vector 36 (for user or MR30)
.word    NOTUSE                ; vector 37 (for user or MR30)
.word    NOTUSE                ; vector 38 (for user or MR30)
.word    NOTUSE                ; vector 39 (for user or MR30)
.word    NOTUSE                ; vector 40 (for user or MR30)
.word    NOTUSE                ; vector 41 (for user or MR30)
.word    NOTUSE                ; vector 42 (for user or MR30)
.word    NOTUSE                ; vector 43 (for user or MR30)
.word    NOTUSE                ; vector 44 (for user or MR30)
.word    NOTUSE                ; vector 45 (for user or MR30)
.word    NOTUSE                ; vector 46 (for user or MR30)
.word    NOTUSE                ; vector 47 (for user or MR30)

.SECTION INTER,ROMDATA        ; Declares FOMDATA attribute section of section name "INTER"
.ORG     FIX_VECTOR           ; Sets location to FFFDCH
.LWORD   NOTUSE               ; FFFDC to F Undefined instruction
.LWORD   NOTUSE               ; FFFE0 to 3 Overflow
.LWORD   NOTUSE               ; FFFE4 to 7 BRK instruction
.LWORD   NOTUSE               ; FFFE8 to B Address coincidence
.LWORD   NOTUSE               ; FFFEC to F Single stepping
.LWORD   NOTUSE               ; FFFF0 to 3 Watchdog timer
.LWORD   NOTUSE               ; FFFF4 to 7 Debugger
.LWORD   NOTUSE               ; FFFF8 to B NMI
.LWORD   RESET                ; FFFFC to F Reset

;-----;
; End of assemble direction ;
;-----;

.END ;

```

5. Reference

SOFTWARE MANUAL

R8C/Tiny Series SOFTWARE MANUAL

(Acquire the most current version from Renesas web-site)

6. Web-site and contact for support

Renesas Web-site

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REVISION HISTORY

Rev.	Date	Description	
		Page	Summary
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